



AF/2827

Atty. Docket No. 8013-1147

PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

BOX AF

Hirokazu HONDA

Confirmation No. 7187

Serial No. 09/678,609

GROUP 2827

Filed October 4, 2000

Examiner D. Graybill

MULTILAYER INTERCONNECTION BOARD,
SEMICONDUCTOR DEVICE HAVING THE SAME,
AND METHOD OF FORMING THE SAME AS
WELL AS METHOD OF MOUNTING THE SEMICONDUCTOR
CHIP ON THE INTERCONNECTION BOARD

AMENDMENT AFTER FINAL REJECTION

Commissioner for Patents

Washington, D.C. 20231

Sir:

Responsive to the Official Action of November 12, 2002 consideration of the remarks that follow the claims and allowance of the application are respectfully requested. This response follows the format suggested in the Notice mailed December 20, 2002. The claims are set forth in a separate section following this introduction and the remarks are set forth in a separate section following the claims.

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